

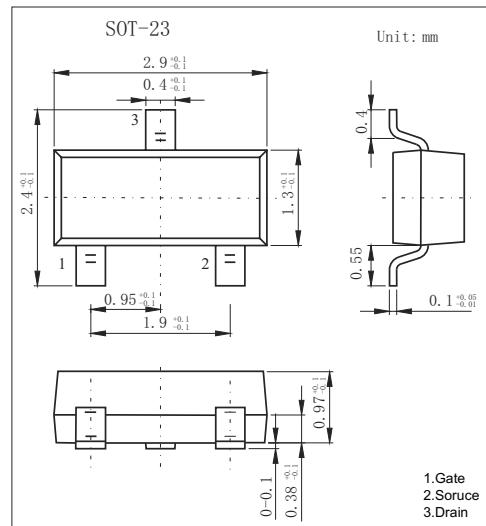
SOT-23 Plastic-Encapsulate MOSFETS

FEATURE

- TrenchFET Power MOSFET
- P-Channel 20-V(D-S) MOSFET

MECHANICAL DATA

- Case style:SOT-23molded plastic
- Mounting position:any



MAXIMUM RATINGS AND CHARACTERISTICS

@ 25°C Ambient Temperature (unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	-20	V
Gate-Source Voltage	V _{GS}	±8	
Continuous Drain Current	I _D	-2.3	A
Pulsed Drain Current	I _{DM}	-10	
Continuous Source-Drain Diode Current	I _S	-0.72	
Maximum Power Dissipation	P _D	0.35	W
Thermal Resistance from Junction to Ambient(t ≤5s)	R _{θJA}	357	°C/W
Junction Temperature	T _J	150	°C
Storage Temperature	T _{stg}	-55 ~+150	

RATINGS AND CHARACTERISTIC CURVES

MOSFET ELECTRICAL CHARACTERISTICS $T_a=25^{\circ}\text{C}$ unless otherwise specified

Parameter	Symbol	Test Condition	Min	Typ	Max	Units
Static						
Drain-source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_{\text{D}} = -250\mu\text{A}$	-20			V
Gate-source threshold voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = -250\mu\text{A}$	-0.4		-1	
Gate-source leakage	I_{GSS}	$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 8\text{V}$			± 100	nA
Zero gate voltage drain current	I_{DSS}	$V_{\text{DS}} = -20\text{V}, V_{\text{GS}} = 0\text{V}$			-1	μA
Drain-source on-state resistance ^a	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = -4.5\text{V}, I_{\text{D}} = -2.8\text{A}$		0.090	0.112	Ω
		$V_{\text{GS}} = -2.5\text{V}, I_{\text{D}} = -2.0\text{A}$		0.110	0.142	
Forward transconductance ^a	g_{fs}	$V_{\text{DS}} = -5\text{V}, I_{\text{D}} = -2.8\text{A}$		6.5		S
Dynamic^b						
Input capacitance	C_{iss}	$V_{\text{DS}} = -10\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		405		pF
Output capacitance	C_{oss}			75		
Reverse transfer capacitance	C_{rss}			55		
Total gate charge	Q_g	$V_{\text{DS}} = -10\text{V}, V_{\text{GS}} = -4.5\text{V}, I_{\text{D}} = -3\text{A}$		5.5	10	nC
Gate-source charge	Q_{gs}			3.3	6	
Gate-drain charge	Q_{gd}			0.7		
Gate resistance	R_g			1.3		
Turn-on delay time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = -10\text{V}, R_L = 10\Omega, I_{\text{D}} = -1\text{A}, V_{\text{GEN}} = -4.5\text{V}, R_g = 1\Omega$		6.0		Ω
Rise time	t_r			11	20	ns
Turn-off delay time	$t_{\text{d}(\text{off})}$			35	60	
Fall time	t_f			30	50	
Drain-source body diode characteristics						
Continuous source-drain diode current	I_s	$T_C = 25^{\circ}\text{C}$			-1.3	A
Pulse diode forward current ^a	I_{SM}				-10	
Body diode voltage	V_{SD}	$I_s = -0.7\text{A}$		-0.8	-1.2	V

Notes :

- a.Pulse Test : Pulse Width < 300μs, Duty Cycle ≤2%.
- b.Guaranteed by design, not subject to production testing.

MARKING: S1

Typical Characteristics

